

## High voltage fast-switching PNP power transistor

### Features

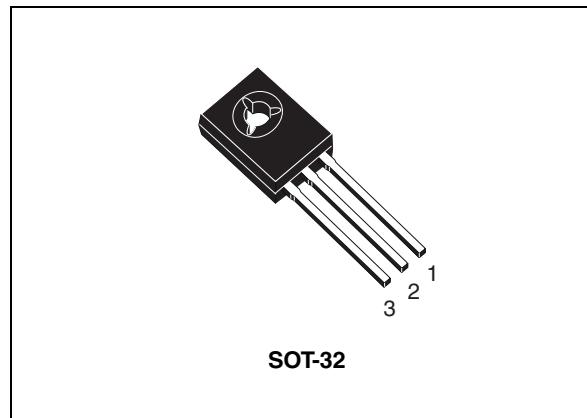
- High voltage capability
- Very high switching speed

### Application

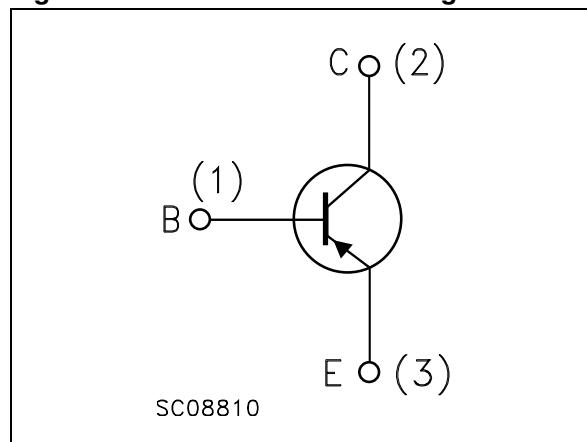
- Electronic ballast for fluorescent lighting

### Description

The device is manufactured using high voltage multi epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA. The ST93003 is expressly designed for a new solution to be used in compact fluorescent lamps, where it is coupled with the ST83003, its complementary NPN transistor.



**Figure 1. Internal schematic diagram**



**Table 1. Device summary**

Order code	Marking	Package	Packaging
ST93003	93003	SOT-32	Bag

## Contents

<b>1</b>	<b>Electrical ratings</b>	<b>3</b>
<b>2</b>	<b>Electrical characteristics</b>	<b>4</b>
2.1	Electrical characteristics (curves)	5
<b>3</b>	<b>Test circuits</b>	<b>7</b>
<b>4</b>	<b>Package mechanical data</b>	<b>8</b>
<b>5</b>	<b>Revision history</b>	<b>10</b>

# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage ( $V_{BE} = 0$ )	-500	V
$V_{CEO}$	Collector-emitter voltage ( $I_B = 0$ )	-400	V
$V_{EBO}$	Emitter-base voltage ( $I_C = 0$ , $I_B = -0.75$ A, $t_p < 10$ $\mu$ s)	$V_{(BR)EBO}$	V
$I_C$	Collector current	-1.5	A
$I_{CM}$	Collector peak current ( $t_p < 5$ ms)	-3	A
$I_B$	Base current	-0.75	A
$I_{BM}$	Base peak current ( $t_p < 5$ ms)	-1.5	A
$P_{TOT}$	Total dissipation at $T_c = 25$ °C	40	W
$T_{STG}$	Storage temperature	-65 to 150	°C
$T_J$	Max. operating junction temperature	150	°C

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJC}$	Thermal resistance junction-case max	3.1	°C/W

## 2 Electrical characteristics

$T_{case} = 25^\circ\text{C}$  unless otherwise specified

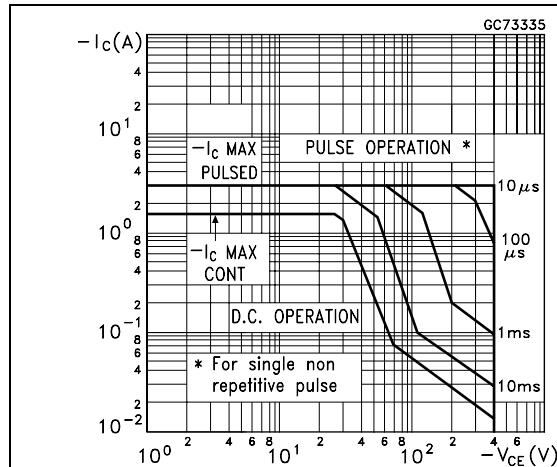
**Table 4. On/off states**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
$I_{CES}$	Collector cut-off current ( $V_{BE} = 0$ )	$V_{CE} = -500 \text{ V}$ $V_{CE} = -500 \text{ V}, T_C = 125^\circ\text{C}$			-1 -5	mA mA
$V_{(BR)EBO}$	Emitter-base breakdown voltage ( $I_C = 0$ )	$I_E = -10 \text{ mA}$	-5		-10	V
$V_{CEO(sus)}^{(1)}$	Collector-emitter sustaining voltage ( $I_B = 0$ )	$I_C = -10 \text{ mA}$	-400			V
$V_{CE(\text{sat})}^{(1)}$	Collector-emitter saturation voltage	$I_C = -0.5 \text{ A}, I_B = -0.1 \text{ A}$ $I_C = -0.35 \text{ A}, I_B = -50 \text{ mA}$			-0.5 -0.5	V V
$V_{BE(\text{sat})}^{(1)}$	Base-emitter saturation voltage	$I_C = -0.5 \text{ A}, I_B = -0.1 \text{ A}$			-1	V
$h_{FE}^{(1)}$	DC current gain	$I_C = -10 \text{ mA}, V_{CE} = -5 \text{ V}$ $I_C = -0.35 \text{ A}, V_{CE} = -5 \text{ V}$ $I_C = -1 \text{ A}, V_{CE} = -5 \text{ V}$	10 16 4	25	32	
$t_r$ $t_s$ $t_f$	Resistive load Rise time Storage time Fall time	$I_C = -0.35 \text{ A}, V_{CC} = 125 \text{ V}$ , $I_{B1} = -70 \text{ mA}, I_{B2} = 70 \text{ mA}$ $t_p \geq 25 \mu\text{s}$ see <a href="#">Figure 14</a>	1.5	90 2.2 0.1	2.9	ns μs μs
$t_s$ $t_f$	Inductive load Storage time Fall time	$I_C = -0.5 \text{ A}, I_{B1} = -0.1 \text{ A}$ , $V_{BE(\text{off})} = 5 \text{ V}$ , $L = 10 \text{ mH}, V_{clamp} = 300 \text{ V}$ see <a href="#">Figure 13</a>		400 40		ns ns
$E_{sb}$	Avalanche energy	$L = 4 \text{ mH}, C = 1.8 \text{ nF}$ , $I_{BR} = 2.5 \text{ A}, 25^\circ\text{C} < T_C < 125^\circ\text{C}$	12			mJ

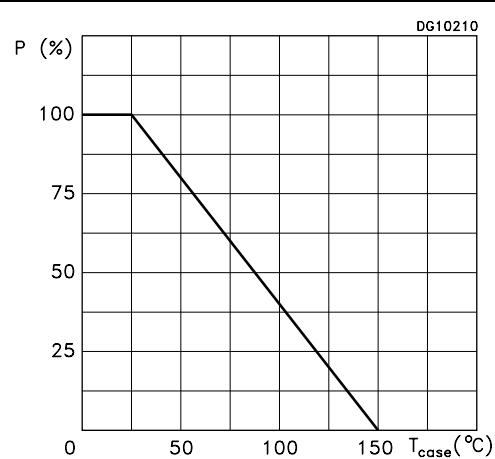
1. Pulse test: pulse duration  $300 \leq \mu\text{s}$ , duty cycle  $\leq 2\%$

## 2.1 Electrical characteristics (curves)

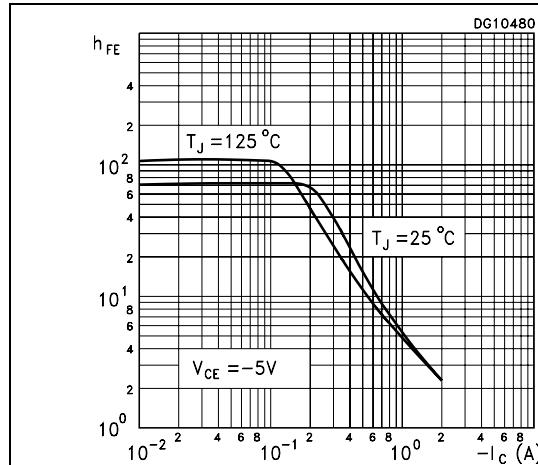
**Figure 2.** Safe operating area



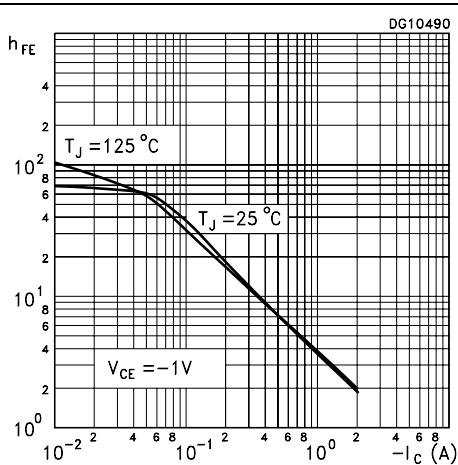
**Figure 3.** Derating



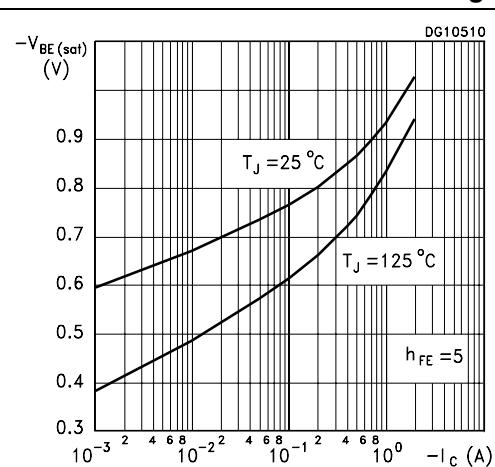
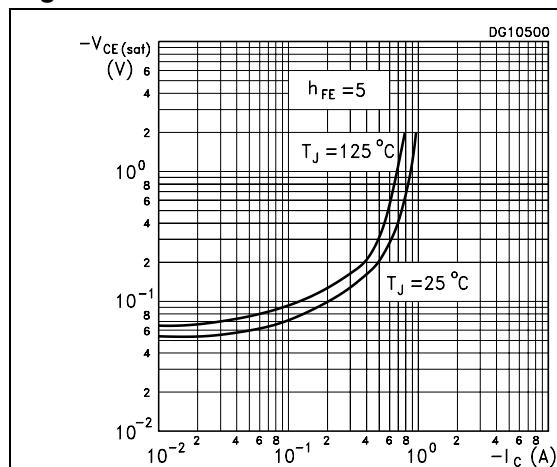
**Figure 4.** DC current gain ( $V_{CE} = -5\text{ V}$ )

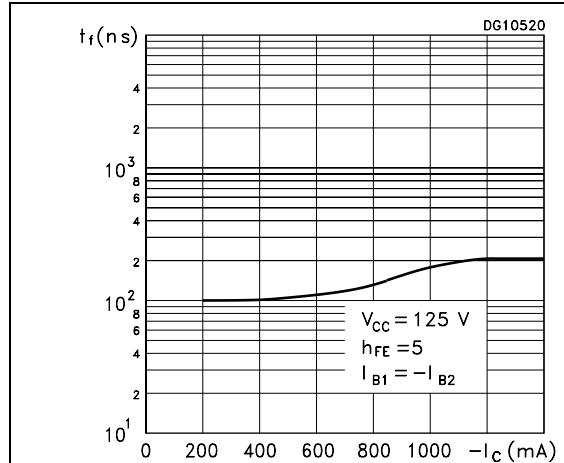
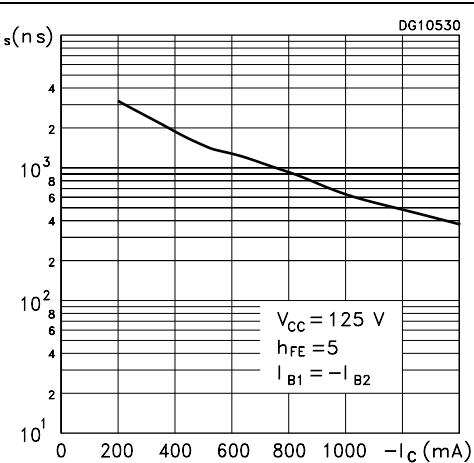
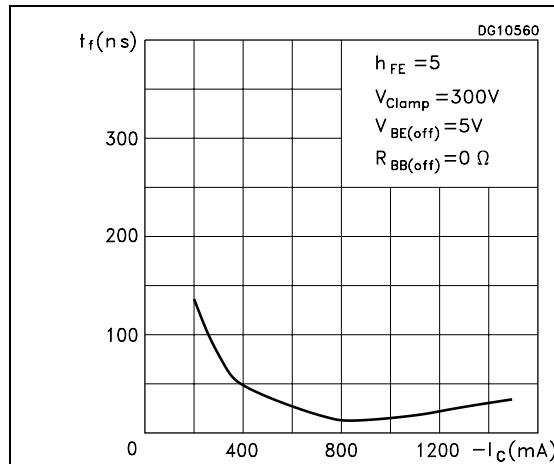
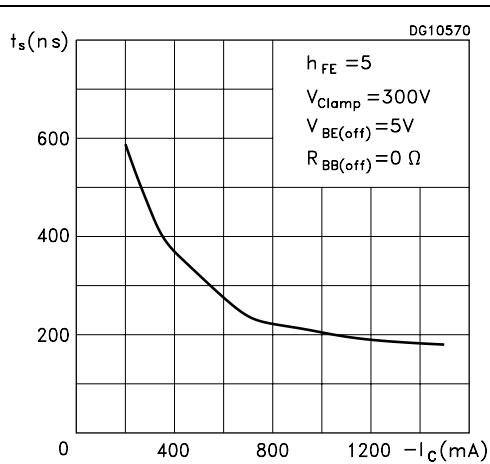
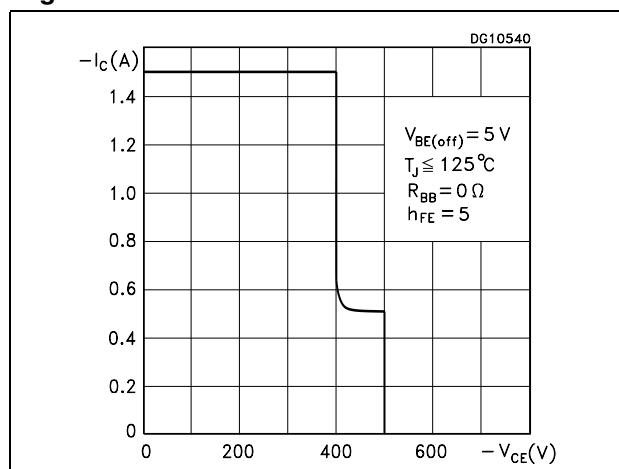


**Figure 5.** DC current gain ( $V_{CE} = -1\text{ V}$ )



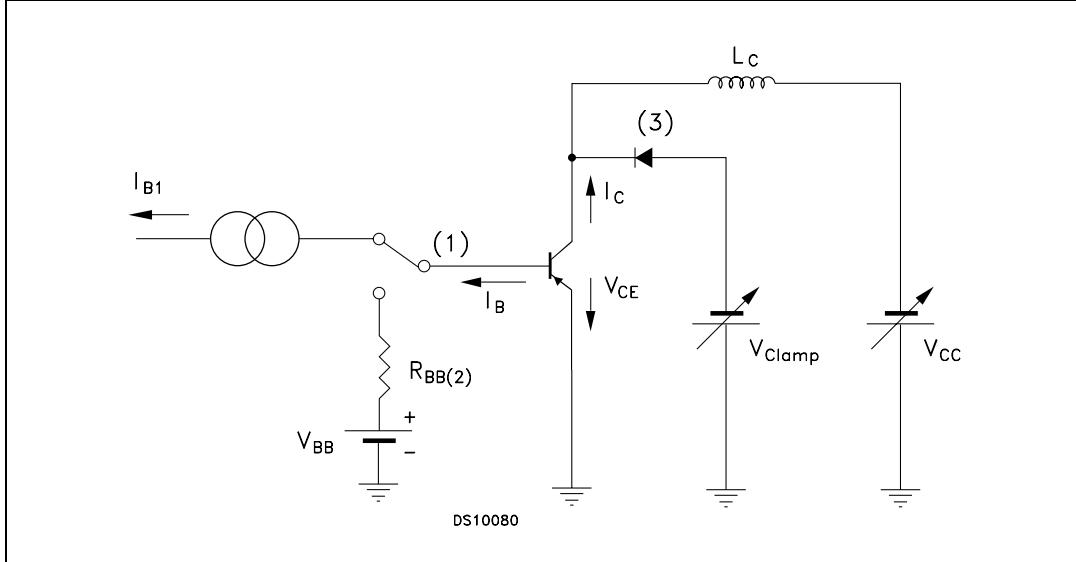
**Figure 6.** Collector emitter saturation voltage **Figure 7.** Base emitter saturation voltage



**Figure 8. Resistive load fall time****Figure 9. Resistive load storage time****Figure 10. Inductive load fall time****Figure 11. Inductive load storage time****Figure 12. Reverse biased SOA**

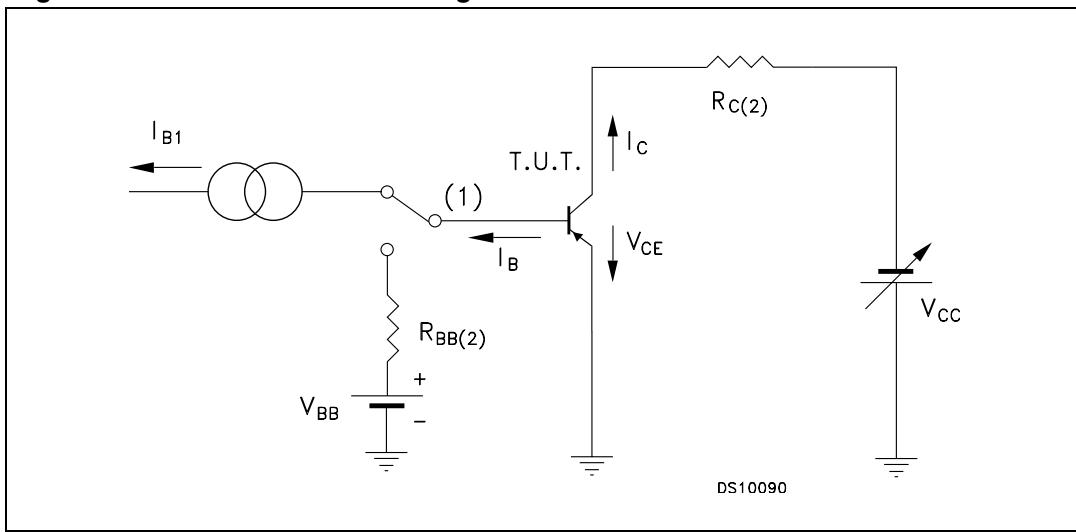
### 3 Test circuits

**Figure 13. Inductive load switching**



1. Fast electronic switch
2. Non-inductive resistor
3. Fast recovery rectifier

**Figure 14. Resistive load switching**



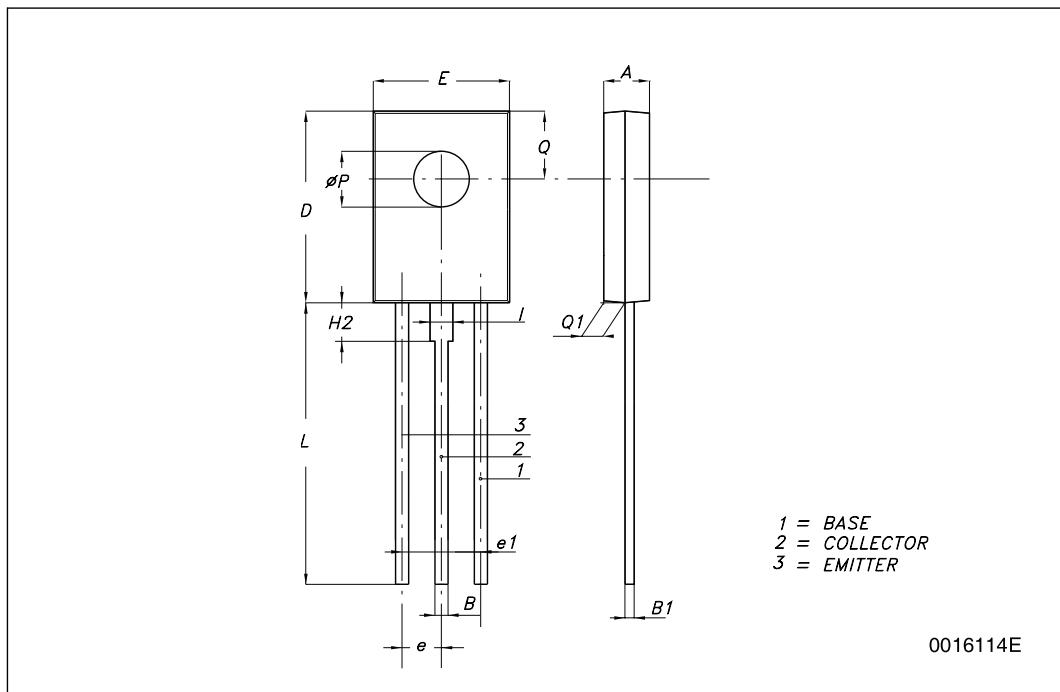
1. Fast electronic switch
2. Non-inductive resistor

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

**SOT-32 (TO-126) MECHANICAL DATA**

DIM.	mm.		
	MIN.	TYP	MAX.
A	2.4		2.9
B	0.64		0.88
B1	0.39		0.63
D	10.5		11.05
E	7.4		7.8
e	2.04	2.29	2.54
e1	4.07	4.58	5.08
L	15.3		16
P	2.9		3.2
Q		3.8	
Q1	1		1.52
H2		2.15	
I		1.27	



## 5 Revision history

**Table 5. Document revision history**

Date	Revision	Changes
08-Jul-2008	3	Mechanical data has been updated.
08-Sep-2009	4	Updated packaging information <a href="#">Table 1 on page 1</a> .
06-Dec-2010	5	Added <a href="#">Table 3: Thermal data on page 3</a> .

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